

April 2015

FDB082N15A N-Channel PowerTrench[®] MOSFET 150 V, 117 A, 8.2 mΩ

Features

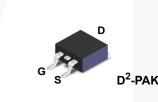
- $R_{DS(on)}$ = 6.7 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 75 A
- · Fast Switching Speed
- Low Gate Charge, Q_G = 64.5 nC (Typ.)
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

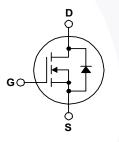
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

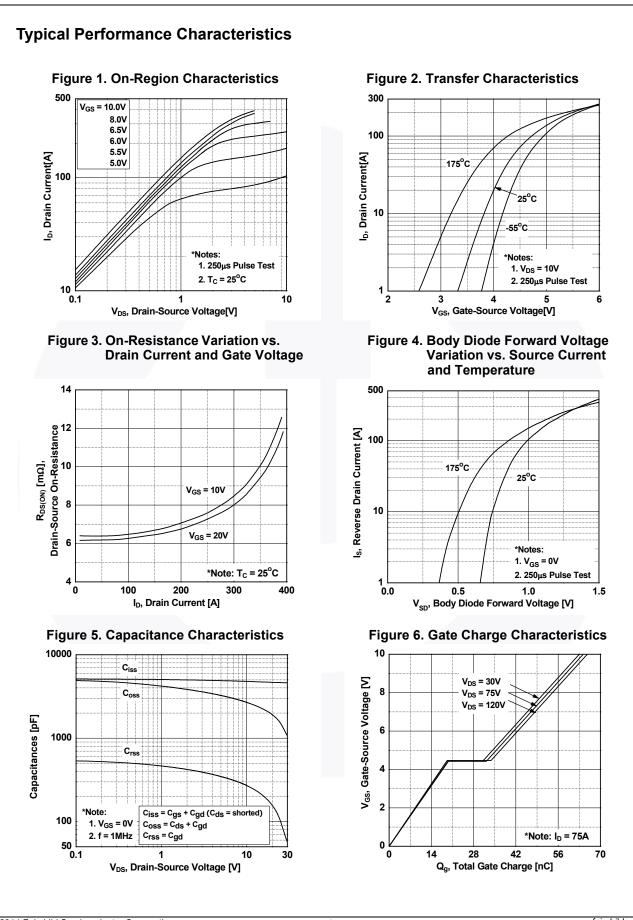
Symbol		FDB082N15A	Unit		
V _{DSS}	Drain to Source Voltage		150	V	
V _{GSS}	Cata to Source Maltage	- DC	±20	V	
	Gate to Source Voltage	- AC (f > 1 Hz)	±30	v	
I _D	Drain Current	- Continuous (T _C = 25 ^o C, Silicon Limited)	117	A	
	Drain Current	- Continuous (T _C = 100 ^o C, Silicon Limited)	83		
I _{DM}	Drain Current	- Pulsed (Note 1)	468	Α	
E _{AS}	Single Pulsed Avalanche Energ	542	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3		6	V/ns	
P _D	Dower Discinction	(T _C = 25°C)	294	W	
	Power Dissipation	- Derate Sbove 25°C	1.96	W/ºC	
T _J , T _{STG}	Operating and Storage Temper	-55 to +175	°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

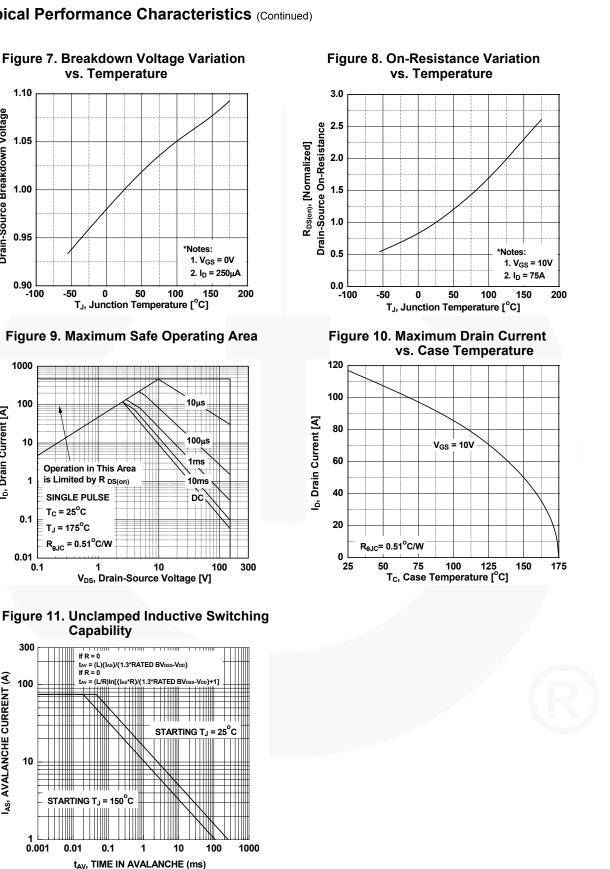
Thermal Characteristics

Symbol	Parameter	FDB082N15A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.51	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	0/00

Part Nur	nber	Top Mark	Packag	e Packing Metho	d Reel Size	Тар	e Width	Qua	Intity
FDB0821	N15A	FDB082N15A	D ² -PA	Tape and Reel	330 mm	2	4 mm	800 units	
Electrica	l Chara	acteristics T _c = 28	5°C unless	otherwise noted.					
Symbol		Parameter		Test Cond	litions	Min.	Тур.	Max.	Unit
- Off Charac	cteristics							I	1
BV _{DSS}	Drain to Source Breakdown Voltage		age	I _D = 250 μA, V _{GS} = 0 V, T _C = 25 ^o C		150	-	-	V
∆BV _{DSS}	Breakdown Voltage Temperature		-	$I_D = 250 \ \mu$ A, Referenced to 25° C		_	0.08	_	V/°C
$/\Delta T_J$	Coefficie	Coefficient					0.00		
I _{DSS} Zero G		o Gate Voltage Drain Current		$V_{DS} = 120 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1	μA
I _{GSS}	Gate to F	Body Leakage Current		$V_{DS} = 120 V, T_{C} = 1$ $V_{GS} = \pm 20 V, V_{DS} =$		-	-	500 ±100	nA
				VGS 120 V, VDS				1100	10.4
On Charac	cteristics	i							
V _{GS(th)}	Gate Th	reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250$		2.0	-	4.0	V
R _{DS(on)}		ain to Source On Resist	tance	V _{GS} = 10 V, I _D = 75		-	6.7	8.20	mΩ
9 _{FS}	Forward	Transconductance		V _{DS} = 10 V, I _D = 75	A	-	139	-	S
Dynamic C	Characte	ristics							
C _{iss}		pacitance		V _{DS} = 25 V, V _{GS} = 0 V,		-	4645	6040	pF
C _{oss}		apacitance				-	1445	1880	pF
C _{rss}	Reverse	Transfer Capacitance		_ f = 1 MHz	-	-	100	-	pF
C _{iss}		pacitance		V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		-	4570	6040	pF
C _{oss}	Output C	apacitance				-	460	1880	pF
C _{rss}	Reverse	Transfer Capacitance				-	20	-	pF
Q _{g(tot)}	Total Gat	te Charge at 10V				-	64.5	84	nC
Q _{gs}	Gate to S	Source Gate Charge		$V_{DS} = 120 \text{ V}, \text{ I}_{D} = 75 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note4)		-	19.1	-	nC
Q _{gs2}	Gate Cha	arge Threshold to Platea	au			-	8.7	-	nC
Q _{gd}	Gate to D	Drain "Miller" Charge				-	13.5	-	nC
ESR	Equivale	nt Series Resistance (G	i-S)	f = 1 MHz		-	2.5	-	Ω
Switching	Charact	eristics							
							22	54	
t _{d(on)} t		Delay Time Rise Time		V _{DD} = 75 V, I _D = 75		-	58	126	ns
t _r		Delay Time		V_{GS} = 10 V, R _G = 4.7 Ω (Note4)			61	132	ns
t _{d(off)} t _f		Fall Time				-	26	62	ns
							20	02	110
Drain-Sou	1	e Characteristics					r		
I _S	Maximum Continuous Drain to Source Diode Forward Current					-	-	117	A
I _{SM}		n Pulsed Drain to Source			•	-	-	468	A
V _{SD}		Source Diode Forward V	/oltage	$V_{GS} = 0 V, I_{SD} = 75 A$ $V_{GS} = 0 V, I_{SD} = 75 A,$ $dI_{F}/dt = 100 A/\mu s$		-	-	1.25	V
t _{rr} Q _{rr}		Recovery Time Recovery Charge				-	96 268	-	ns nC
Qrr	Reveise	Recovery charge				-	200		

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Typical Performance Characteristics (Continued)

1.10

1.05

1.00

0.95

0.90 └ -100

1000

100

10

1

0.1

0.01

300

100

10

0.001

I_{AS}, AVALANCHE CURRENT (A)

0.1

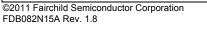
Drain Current [A]

ê

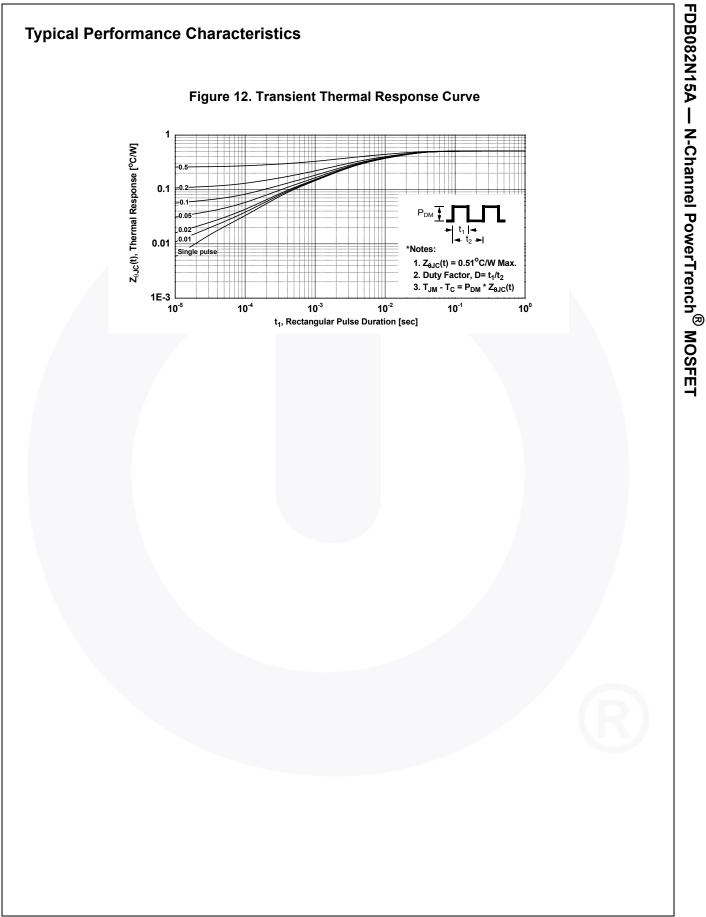
-50

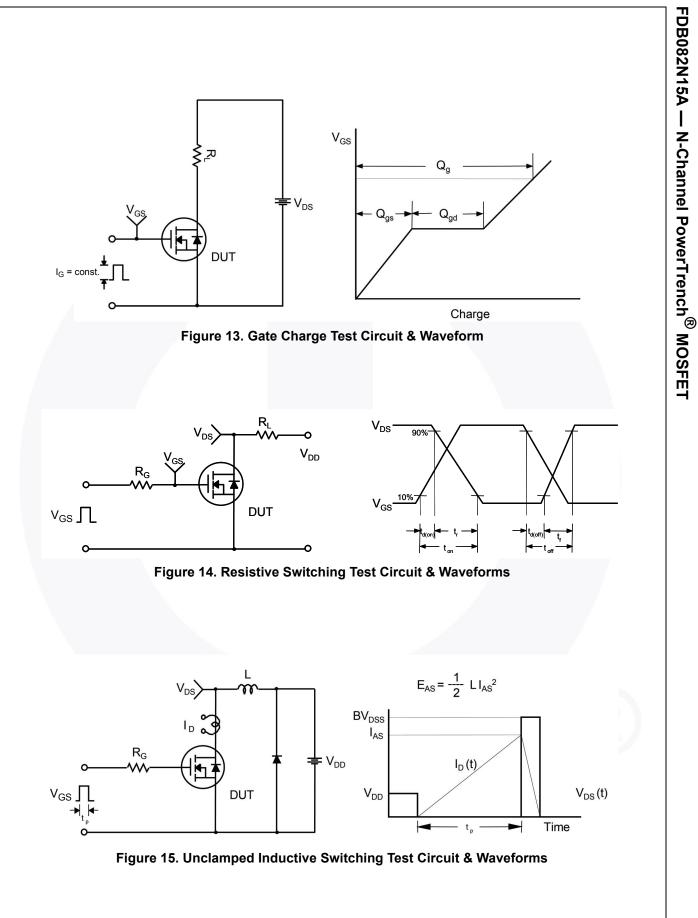
Drain-Source Breakdown Voltage

BV_{DSS}, [Normalized]



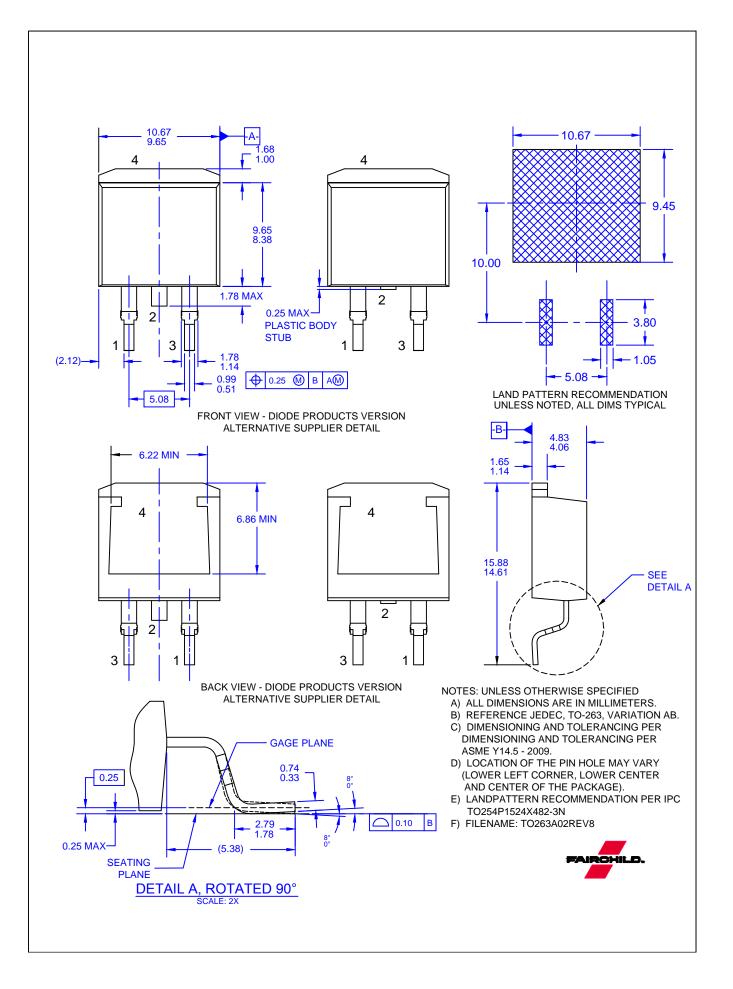
0.01





DUT + V_{DS} a ۱_{SD} م L Driver R_G, Same Type as DUT L F V_{DD} $\prod V_{GS}$ • dv/dt controlled by R_G • I_{SD} controlled by pulse period Î Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) I_{FM}, Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{DD} Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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